RF Front-End DSP

A THESIS

Submitted by

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THESIS CERTIFICATE

This is to certify that the thesis titled "RF Front-End DSP", submitted by Sameer Mathad

(EE17M022), to the Indian Institute of Technology, Madras, for the award of the degree of

Master of Technology, is a bona fide record of the project work done by her under my

supervision. The contents of this thesis, in full or in parts, have not been submitted to any other

Institute or University for the award of any degree or diploma.

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1

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ABSTRACT

ADRV9009 is a dual-channel RF transmitter and receiver with an observation receiver that operates over a frequency range of 75 MHz to 6 GHz with a high speed ADC/DAC running at 2 GSPS. The device supports up to 450 MHz of synthesis bandwidth on its transmitters and a dual-channel receiver that supports bandwidths up to 200 MHz. This thesis provides a description of all the blocks inside the ADRV9009 and a way to configure each of them.

Due to confidentiality issues only abstract is uploaded. Complete thesis has been submitted to **Dr. Radha Krishna Ganti**. Kindly contact the professor for full thesis.

REFERENCES

- 1) ADRV9009 Hardware Referance Manual.
- 2) P. Vaidyanathan and Truong Nguyen, "A 'trick' for the design of FIR half-band filters," in *IEEE Transactions on Circuits and Systems*, vol. 34, no. 3, pp. 297-300, March 1987.